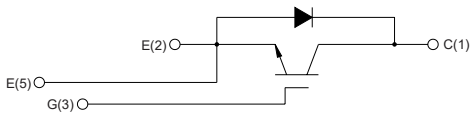


SGO400T120UC3

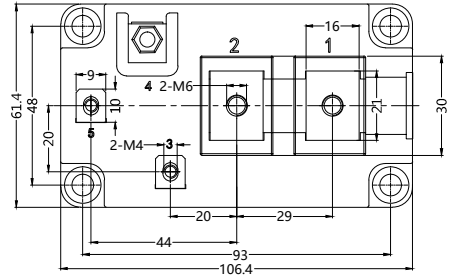
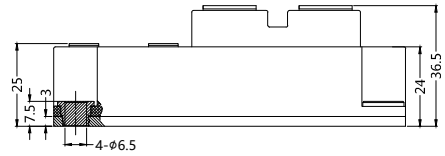
IGBT Modules



SGO400T120UC3



Dimensions in mm (1mm = 0.0394")



T_c = 25°C, unless otherwise specified

Symbol	Conditions	Values	Units
IGBT			
V _{CES}		1200	V
I _{Cnom}		400	A
I _{CRM}	T _c =25°C, t _p = 1ms	800	A
V _{GES}		±20	V
T _{vj}		-40...+175	°C
Inverse Diode			
I _F	T _c =25(80)°C	600(400)	A
I _{FRM}	T _c =25°C, t _p = 1ms	800	A
I _{FSM}	t _p =10ms; sin180°; T _j =45°C	2500	A
Module			
I _{t(RMS)}	T _{terminal} =80°C	500	A
T _{stg}		-40~125	°C
V _{isol}	AC, 1min	4000	V

Features

- Trench Field Stop IGBT4 technology
- Low switching losses
- Switching frequency up to 20kHz
- Square RBSOA, no latch up
- High short circuit capability
- Positive temperature coefficient for easy parallelling
- MOS input, voltage controlled
- Soft switching free wheeling diode Technology
- Package with copper base plate
- Isolation voltage 4000V

Application

- AC and DC motor control
- AC servo and robot drives
- power supplies
- welding inverters

Advantages

- space and weight savings
- reduced protection circuits

SGO400T120UC3

IGBT Modules

Characteristics

T_c = 25°C, unless otherwise specified

Symbol	Conditions	min.	typ.	max.	Units
IGBT					
V _{GE(th)}	V _{GE} =V _{CE} , I _C =15mA	5.0	5.8	6.5	V
I _{CES}	V _{GE} =0; V _{CE} =V _{CES} ; T _j =125°C			5	mA
V _{CE(TO)}	T _j =25°C		0.8	0.9	V
r _{CE}	V _{GE} =15V, T _j =25(150°C)		2.5(3.7)	2.8(4.0)	mΩ
V _{CE(sat)}	I _C =400A; V _{GE} =15V; chip level		1.95	2.35	V
C _{ies}	under following conditions		24.3		nF
C _{oes}	V _{GE} =0, V _{CE} =25V, f=1MHz		1.61		
C _{res}			1.38		
L _{CE}				20	nH
R _{CC'+EE'}	res., terminal-chip T _c =25(125)°C		0.25(0.5)		mΩ
t _{d(on)}	under following conditions:		235		ns
t _r	V _{CC} =600V, I _C =400A		50		ns
t _{d(off)}	R _{Gon} =R _{Goff} =1Ω, T _j =150°C		495		ns
t _f	V _{GE} =±15V		88		ns
E _{on} (E _{off})			27(45)		mJ
Inverse Diode under following conditions:					
V _F = V _{EC}	I _F =400A; V _{GE} =0V; T _j =25(150)°C		2.20(2.15)	2.52(2.47)	V
V _(FO)	T _j =25(150)°C		1.30(0.90)	1.50(1.10)	V
r _F	T _j =25(150)°C		2.3(3.3)	2.5(3.4)	mΩ
I _{RRM}	I _F =400A; T _j =150°C		440		A
Q _{rr}	di/dt =7200A/us		77		uC
E _{rr}	V _{GE} =15V		36		mJ
Thermal Characteristics					
R _{th(j-c)}	per IGBT			0.072	K/W
R _{th(j-c)D}	per Inverse Diode			0.14	K/W
R _{th(c-s)}	per module			0.038	K/W
Mechanical Data					
M _s	to heatsink M6	3		5	Nm
M _t	to terminals M6	2.5		5	Nm
	to terminals M4	1.1		2	
Weight	typical			328	g

Sirectifier®

SGO400T120UC3

IGBT Modules

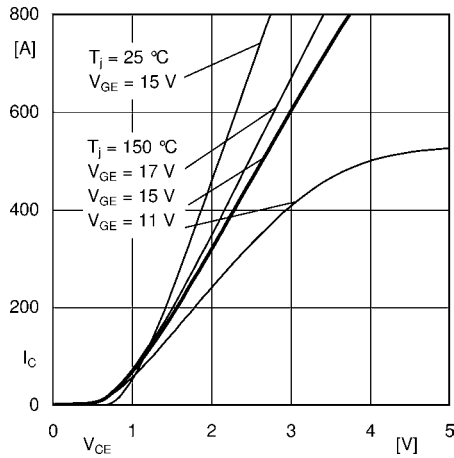


Fig. 1: Typ. output characteristic, inclusive $R_{CC+ EE'}$

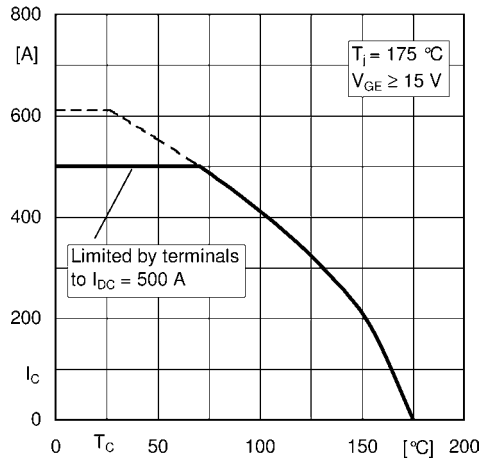


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

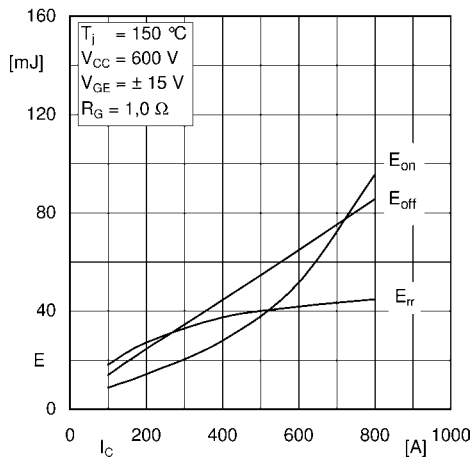


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

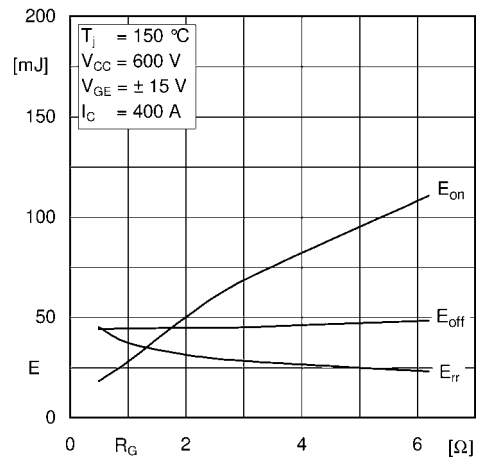


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

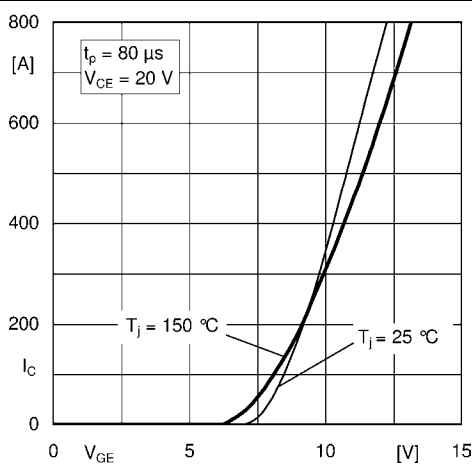


Fig. 5: Typ. transfer characteristic

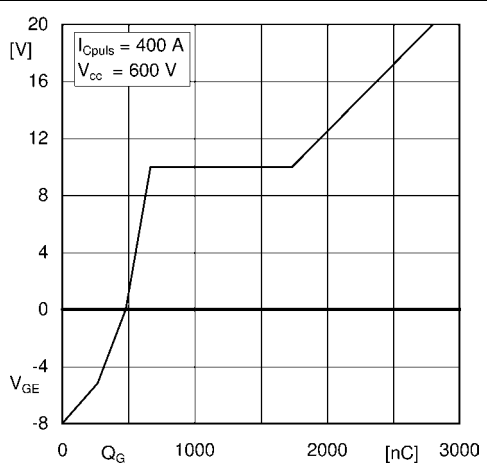


Fig. 6: Typ. gate charge characteristic

SGO400T120UC3

IGBT Modules

